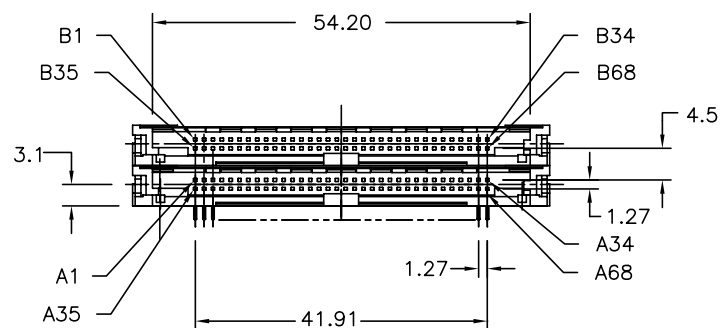
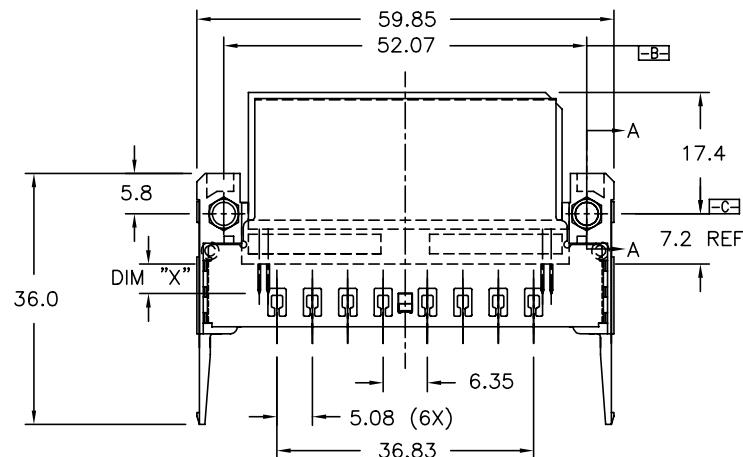
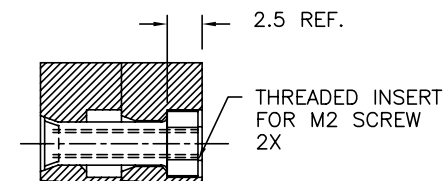
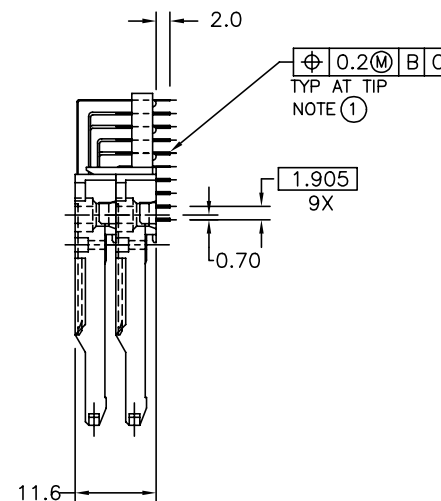


PRODUCT NO.	DIM "X"		
71257-0000	4.25±0.1	3.5±0.1	5±0.1
71257-0000LF	OTHERS	36,67	1,17,34, 35,51,68

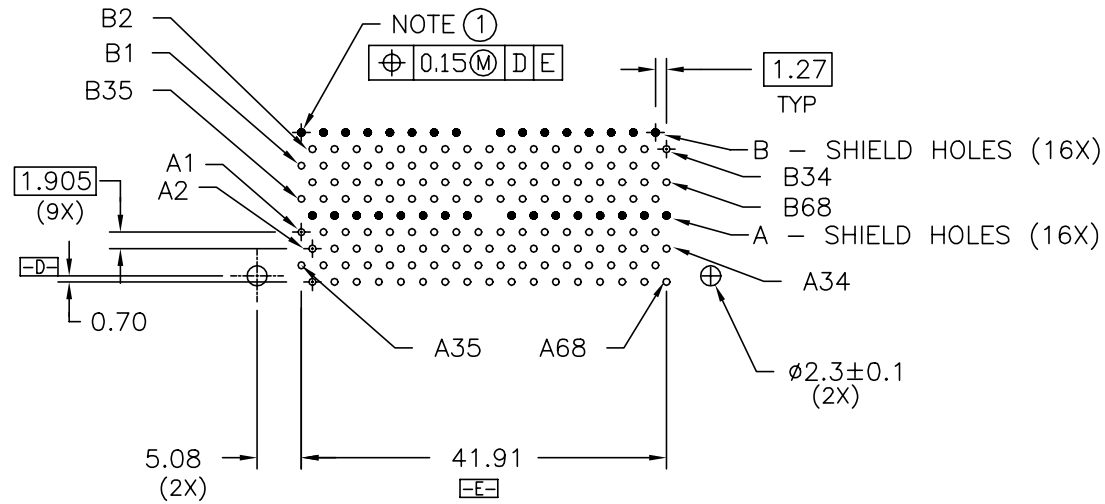


NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- MATERIAL:
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
PIN: COPPER ALLOY
- FINISH (PIN):
UNDER PLATING: 0.5 μ M MIN. Ni
CONTACT AREA: 0.076 μ M MIN. GOLD
SOLDER AREA: 2.5 μ M MIN. Sn-Pb
LEAD FREE SOLDER TAIL PLATING 2 μ m (80u") MIN. MATTE TIN
OVER 1.27 μ m (50u") MIN. NICKEL UNDERPLATE.
- RECOMMENDED SCREW TORQUE: 1.0 TO 1.5 MAX in-lbs.
(1.2-1.7 cm-kgs). RECOMMENDED HOLD DOWN: 2mm
SCREWS (95121-002) AND HEX NUTS (92869-001).
- IF LEAD FREE PART NUMBER, THE HOUSING WILL WITHSTAND EXPOSURE TO 260° C
PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A
1.60mm MIN. THICK CIRCUIT BOARD.
- PACKAGING SPECIFICATION: GS-14-415.
PACKAGING OF LEAD FREE PRODUCTS MEETS LABELING AND PACKAGING
SPECIFICATION GS-14-920.
- LEAD FREE PRODUCTS MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY
REGULATIONS AS DESCRIBED IN GS-22-008.
- PRODUCT SPEC: 110-263

SECTION A-A
SCALE: 4/1

mat'l. code				surface		tolerance	projection	product family				
				ISO1302 ✓		ISO406 ISO1101		PCMCIA				
ltr		ecn	nodr	date		tolerances unless otherwise specified		title				
A	V60110	RHG	01/04/96	angle	line	0.X±0.3			RIGHT ANGLE DOUBLE DECK CARDBUS HEADER ASSEMBLY			
B	V70388	RHG	05/22/97			0.XX±0.13						
C	V12254	TFG	09/24/01			0.XXX±0.05						
				0°±x'		scale 1:1						
D	V12254	HTB	10/08/03	dr	D.SHEAFFER	08/11/95		dwg no		sheet 1 of 2	size	
E	N05-0057	DAI	03/30/05	engr	D.BRANN	08/11/95		71257		A4		
F	EX-N-007944	ZK	11/01/11	chr	D.BRANN	08/11/95						
G	EX-N-011402	ZK	04/23/12	appd	D.BRANN	08/11/95						
sheet		revision		G	G							
index		sheet		1	2							



NOTES:

- ① RECOMMENDED DIAMETER IS $\phi 1.0$. FOR PROCESSES USING PASTE REFLOW, HOLE MAY BE AS SMALL AS $\phi 0.79$.
- 2 ALL TOLERANCES ± 0.15 UNLESS NOTED.

mat'l. code				surface		tolerance		projection		product family							
				ISD1302 ✓		ISD406 ISD1101				PCMCIA							
ltr		ecn		nodr		date		tolerances unless otherwise specified		title							
G								angle		0.X±0.3		 MM		RIGHT ANGLE DOUBLE DECK CARDBUS HEADER ASSEMBLY			
								0'±x'		0.XX±0.13							
										0.XXX±0.05							
								scale 1:1									
				dr		D.SHEAFFER		08/11/95				dwg no		sheet 2 of 2		size	
				engr		D.BRANN		08/11/95				71257		A4			
				chr		D.BRANN		08/11/95									
				appd		D.BRANN		08/11/95									
sheet		revision										type		Product		Customer Drawing	
index		sheet															